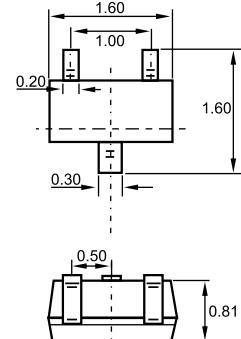


Features

- ✧ Ultra-Small surface mount package.
- ✧ Fast switching speed.
- ✧ For general purpose switching applications.
- ✧ Low conductance.

SOT-523



Applications

- ✧ General purpose switching application.

Dimensions in inches and (millimeters)

Ordering Information

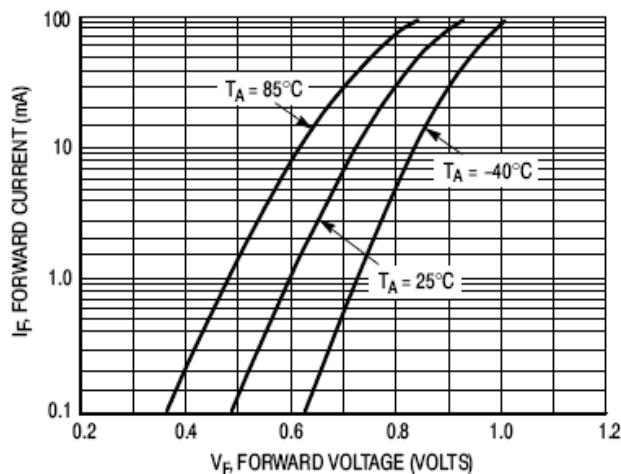
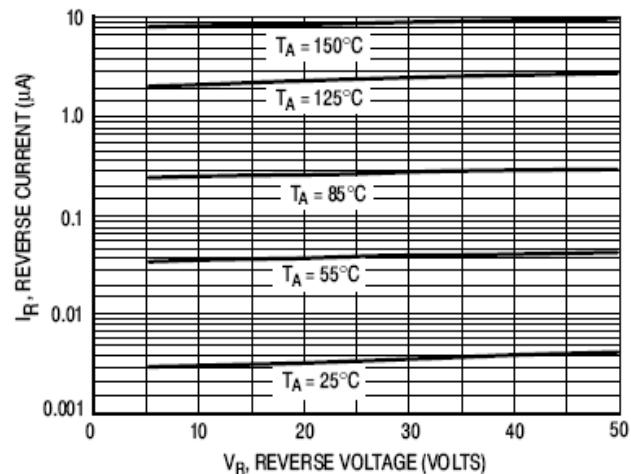
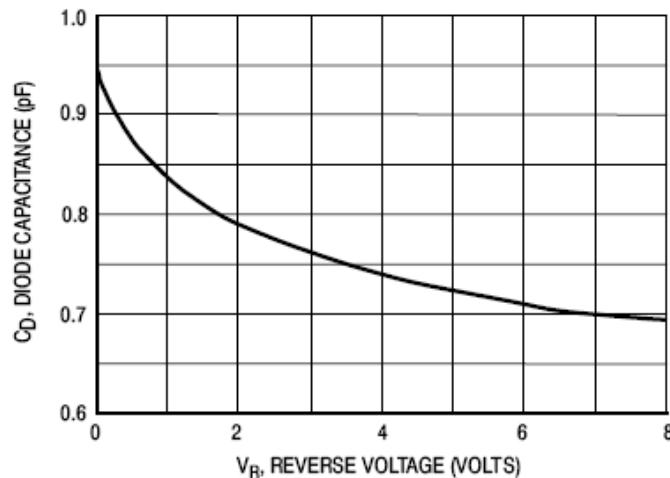
Type No.	Marking	Package Code
DAN222	N	SOT-523

MAXIMUM RATING @ Ta=25°C unless otherwise specified

Symbol	Parameter	Value	Units
V _R	DC reverse voltage	80	V
V _{RM}	Peak reverse voltage	80	V
I _F	Forward continuous voltage	100	mA
I _{FM}	Peak forward current (max.)	300	mA
I _{FSM}	Non-repetitive peak forward surge current @t=1.0μs	2.0	A
P _d	Power dissipation	150	mW
R _{θJA}	Thermal resistance junction to ambient	833	°C/W
T _j , T _{stg}	Junction and Storage Temperature	-55~150	°C

ELECTRICAL CHARACTERISTICS @ Ta=25°C unless otherwise specified

Parameter	Symbol	Test conditions	MIN	MAX	UNIT
Reverse breakdown voltage	V _{(BR)R}	I _R =100μA	80		V
Leakage current	I _R	V _R =70V		0.1	μA
Forward voltage	V _F	I _F =100mA		1.2	V
Diode capacitance	C _D	V _R =6.0V,f=1MHz		3.5	pF
Reverse recovery Time	t _{rr}	I _F =I _R =5.0mA,I _{rr} =0.1*I _R ,R _L =100Ω V _R =6.0V		4.0	ns

TYPICAL CHARACTERISTICS @ $T_A=25^\circ\text{C}$ unless otherwise specified

Figure 1. Forward Voltage

Figure 2. Reverse Current

Figure 3. Diode Capacitance